

42.P17274



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4/20/06

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Fu, et al.

Serial No.: 10/672,357

Filed: September 25, 2003

For: PROCESS FOR LOW K  
DIELECTRIC PLASMA ETCHING WITH  
HIGH SELECTIVITY TO DEEP UV  
PHOTORESIST

Examiner: Binh X. Tran


Group Art Unit: 1765

Attorney Docket No.: 42.P17274

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Katherine Jennings

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**Response Under 37 C.F.R §1.116  
Expedited Procedure  
Technology Center 1700**

**AMENDMENT**

Hon. Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

In response to the March 28, 2006 Final Office Action, please consider the following  
amendments and remarks:

**Amendments to the Claims** begin on page 2.

**Remarks/Arguments** begin on page 7.